

DESCRIPTION

LCXXCI a 3.3V-30V bi-directional TVS diode , utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making his device an ideal solution for protecting voltage sensitive high-speed data lines. The LCX XCI has a low capacitance with a typical value at 1pF,and com - plies with the IEC61000-4-2(ESD) standard with $\pm 30\text{kV}$ air and $\pm 30\text{kV}$ contact discharge. It is assembled into a lead free SOD-323 package. The small size, low capacitance and high ESD surge protection make LCXXCI an idea choice to protect cell phon -e, wireless systems, and communication equipment.

APPLICATIONS

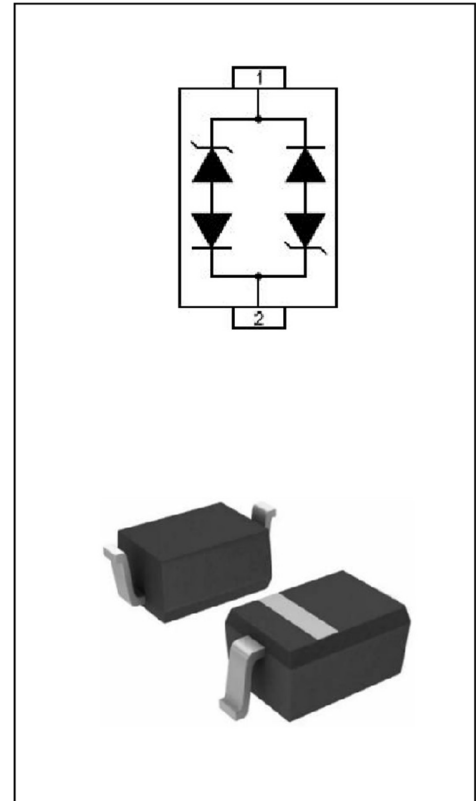
- ◇ USB Ports.
- ◇ Smart Phones.
- ◇ Wireless Systems.
- ◇ Ethernet 10/100/1000 Base T.

FEATURES

- ◇ 350W peak pulse power (8/20 μs).
- ◇ Ultra low capacitance: 1.2pF typical.
- ◇ Ultra low leakage: nA leel.
- ◇ Low operating :3.3V ,5V,8V,12V,15V,18V,24V,30V.
- ◇ Low clamping voltage.
- ◇ Protects one power line or data line.
- ◇ Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test Air discharge: $\pm 30\text{kV}$ Contact discharge: $\pm 30\text{kV}$.
 - IEC61000-4-4 (EFT) 40A (5/50ns).
- ◇ RoHS Compliant.
- ◇ Package: SOD-323.

ORDERING INFORMATION

Part NO	packaging	Reel Size
LC03CI	3000/Tape & Reel	7 inch
LC05CI	3000/Tape & Reel	7 inch
LC08CI	3000/Tape & Reel	7 inch
LC12CI	3000/Tape & Reel	7 inch
LC15CI	3000/Tape & Reel	7 inch
LC18CI	3000/Tape & Reel	7 inch
LC24CI	3000/Tape & Reel	7 inch
LC30CI	3000/Tape & Reel	7 inch



DEVICE CHARACTERISTICS

Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	P _{pp}	350	W
Peak Pulse Current (8/20μs)	I _{pp}	22-6	A
ESD per IEC 61000-4-2 (Air)	V _{ESD}	±30	kV
ESD per IEC 61000-4-2 (Contact)		±30	
Operating Temperature Range	T _J	-40 to +85	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS(T_A=25°C unless otherwise specified)

LC03CI

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V _{RWM}				3.3	V
Breakdown Voltage	V _{BR}	I _T = 1mA	4		6	V
Reverse Leakage Current	I _R	V _{RWM} = 3.3 V			0.2	μA
Clamping Voltage	V _C	I _{PP} = 1A (8 x 20μs pulse)			5	V
Clamping Voltage	V _C	I _{PP} = 22A (8 x 20μs pulse)			16	V
Junction Capacitance	C _J	V _R = 0V, f = 1MHz		1.2		pF

LC05CI

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V _{RWM}				5.0	V
Breakdown Voltage	V _{BR}	I _T = 1mA	6.2	6.8	8.0	V
Reverse Leakage Current	I _R	V _{RWM} = 5.0 V			0.5	μA
Clamping Voltage	V _C	I _{PP} = 1A (8 x 20μs pulse)		8.5		V
Clamping Voltage	V _C	I _{PP} = 22A (8 x 20μs pulse)		17.0	20	V
Junction Capacitance	C _J	V _R = 0V, f = 1MHz		1.0	1.5	pF

LC08CI						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				8.0	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	8.5			V
Reverse Leakage Current	I_R	$V_{RWM} = 8\text{ V}$			0.2	μA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)			13	V
Clamping Voltage	V_C	$I_{PP} = 18\text{A}$ (8 x 20 μs pulse)			19.5	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$		1		pF

LC12CI						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				12.0	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	13.3			V
Reverse Leakage Current	I_R	$V_{RWM} = 12\text{ V}$			0.2	μA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)			18	V
Clamping Voltage	V_C	$I_{PP} = 12\text{A}$ (8 x 20 μs pulse)			29	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$		1.2		pF

LC15CI						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				15.0	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	16.7			V
Reverse Leakage Current	I_R	$V_{RWM} = 15\text{ V}$			0.2	μA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)			22	V
Clamping Voltage	V_C	$I_{PP} = 10\text{A}$ (8 x 20 μs pulse)			32	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$		1.2		pF

LC18CI

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				18.0	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	20			V
Reverse Leakage Current	I_R	$V_{RWM} = 18\text{ V}$			0.2	μA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)			26	V
Clamping Voltage	V_C	$I_{PP} = 10\text{A}$ (8 x 20 μs pulse)			35	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$		1		pF

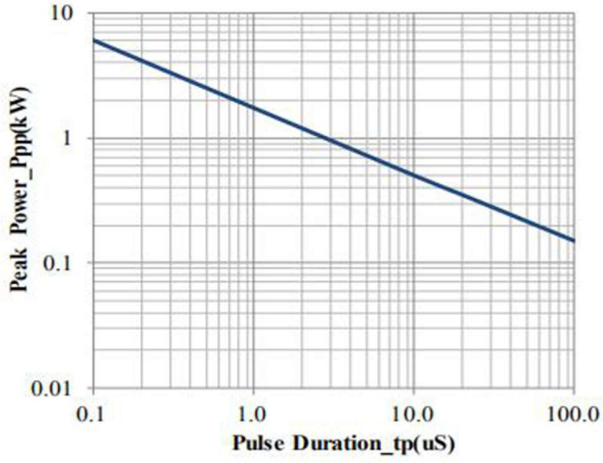
LC24CI

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				24.0	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	26.7			V
Reverse Leakage Current	I_R	$V_{RWM} = 24\text{ V}$			0.2	μA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)			43	V
Clamping Voltage	V_C	$I_{PP} = 8\text{A}$ (8 x 20 μs pulse)			55	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$		1.2		pF

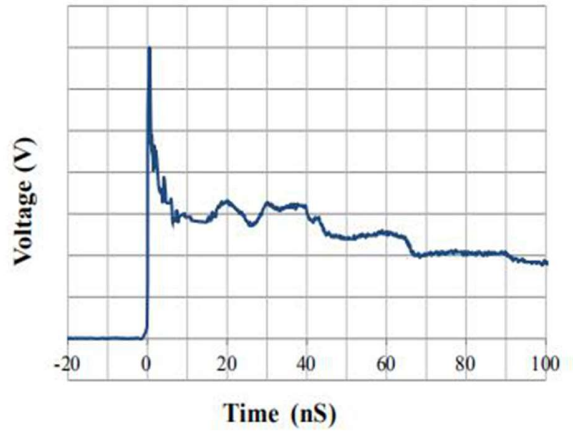
LC30CI

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V_{RWM}				30.0	V
Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	33.3			V
Reverse Leakage Current	I_R	$V_{RWM} = 30\text{ V}$			0.2	μA
Clamping Voltage	V_C	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)			50	V
Clamping Voltage	V_C	$I_{PP} = 10\text{A}$ (8 x 20 μs pulse)			75	V
Junction Capacitance	C_J	$V_R = 0\text{V}$, $f = 1\text{MHz}$		1.2		pF

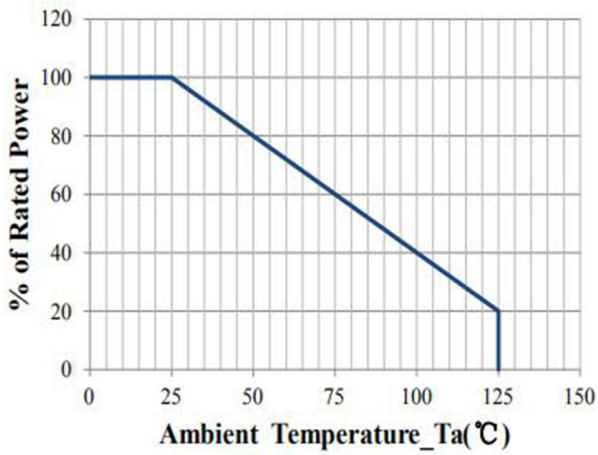
TYPICAL CHARACTERISTICS($T_A=25^{\circ}\text{C}$ unless otherwise Specified)



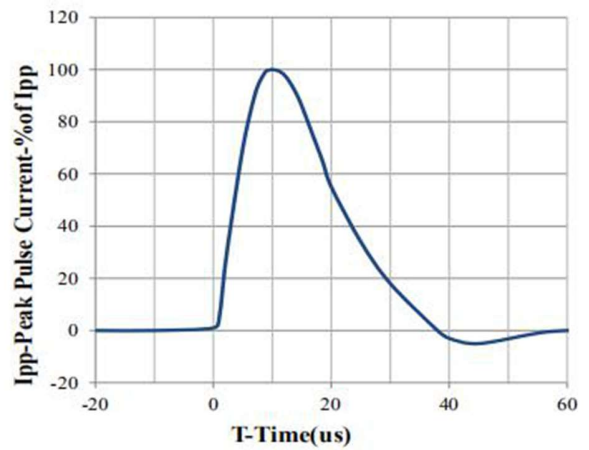
Peak Pulse Power vs. Pulse Time



IEC61000-4-2 Pulse Waveform

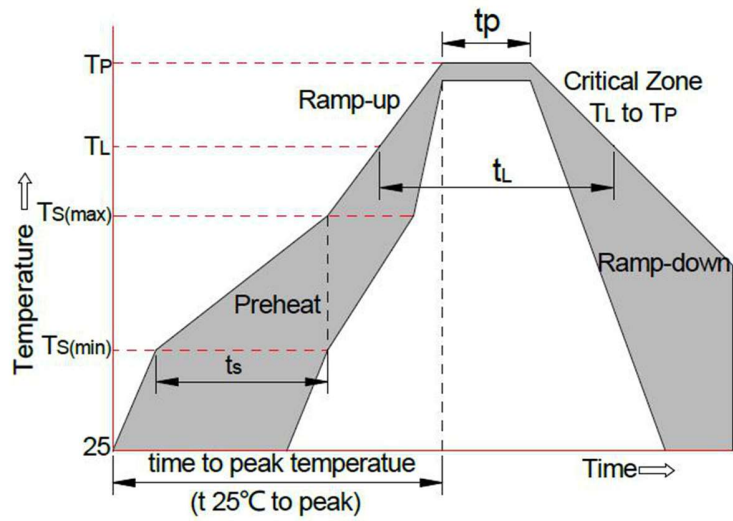


Power Derating Curve



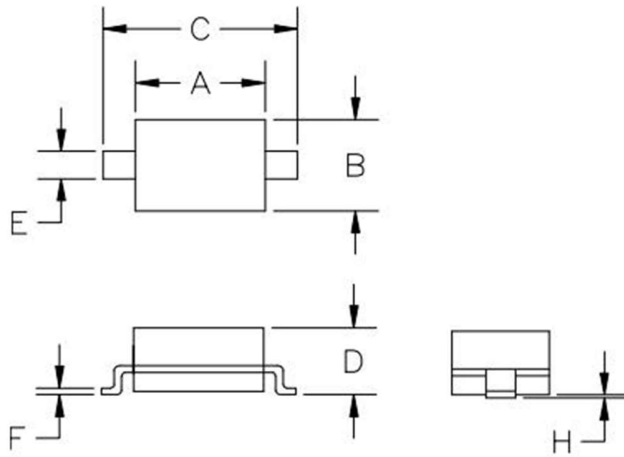
8 X 20us Pulse Waveform

SOLDERING PARAMETERS



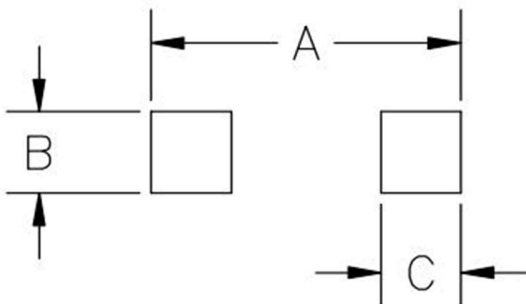
Reflow Condition		Pb-Free Assembly
Pre-heat	-Temperature Min ($T_{s (min)}$)	+150°C
	-Temperature Max ($T_{s (max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs
Average ramp up rate(Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s (max)}$ to T_L -Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature (T_L) (Liquid us)	+217°C
	-Temperature (t_L)	60-150 secs
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6 °C/secs. Max
xTime 25°C to Peak Temp (T_p)		8 min. Max
Do not exceed		+260°C

SOD-323 PACKAGE OUTLINE DRAWING



SYM	DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.50	1.80	0.060	0.071
B	1.20	1.40	0.045	0.054
C	2.30	2.70	0.090	0.107
D	-	1.10	-	0.043
E	0.30	0.40	0.012	0.016
F	0.10	0.25	0.004	0.010
H	-	0.10	-	0.004

SUGGESTED LAND PATTERN



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
A	3.15	0.120
B	0.80	0.031
C	0.80	0.031